

Improved Industry Standard Parallel 12-Bit Multiplying DAC

FEATURES

- Improved Direct Replacement for AD7545A and AD7545
- DNL and INL Over Temperature: $\pm 0.5\text{LSB}$
- Gain Error: $\pm 1\text{LSB}$ Maximum
- 4-Quadrant Multiplication
- Single 5V or 15V Supply
- Low Power Consumption
- Low Cost

APPLICATIONS

- Process Control and Industrial Automation
- Software Controlled Gain Adjustment
- Digitally Controlled Filter and Power Supplies
- Automatic Test Equipment

DESCRIPTION

The LTC[®]7545A is a 12-bit multiplying digital-to-analog converter (DAC) with a microprocessor compatible parallel input. It is a superior pin compatible replacement for the industry standard AD7545A and AD7545. Improvements include better accuracy, better stability over temperature and supply variations and lower sensitivity to output amplifier offset.

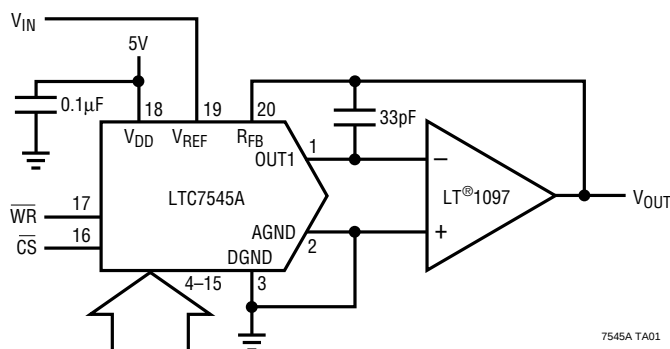
This very versatile DAC is useful for 2-quadrant and 4-quadrant multiplying, programmable gain and filtering and single supply noninverting voltage output operation.

Parts are available in 20-pin PDIP and SO packages and commercial and industrial temperature grades.

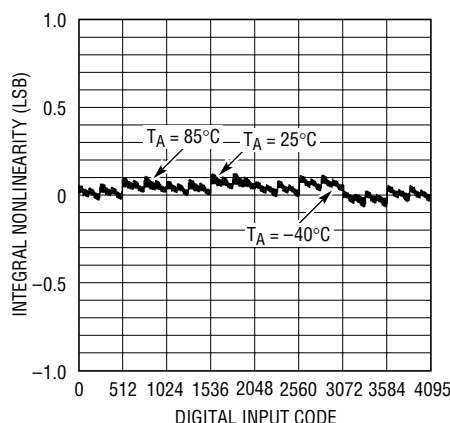
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TYPICAL APPLICATION

**2-Quadrant Multiplying DAC Has Less Than
0.5LSB (Typ) Total Unadjusted Error**



Integral Nonlinearity Over Temperature



ABSOLUTE MAXIMUM RATINGS

V_{DD} to AGND	–0.5V to 17V
V_{DD} to DGND	–0.5V to 17V
AGND to DGND	–0.5V to $V_{DD} + 0.5V$
DGND to AGND	–0.5V to $V_{DD} + 0.5V$
V_{REF} to AGND, DGND	$\pm 25V$
R_{FB} to AGND, DGND	$\pm 25V$
Digital Inputs to DGND	–0.5V to $V_{DD} + 0.5V$
V_{OUT1} to AGND, DGND	–0.5V to $V_{DD} + 0.5V$
Maximum Junction Temperature	150°C
Operating Temperature Range	
Commercial (K, L Versions)	0°C to 70°C
Industrial (B, C Versions)	–40°C to 85°C
Storage Temperature Range	–65°C to 150°C
Lead Temperature (Soldering, 10 sec)	300°C

PACKAGE/ORDER INFORMATION

TOP VIEW		ORDER PART NUMBER
OUT1 [1]	[20] R_{FB}	LTC7545ABG
AGND [2]	[19] V_{REF}	LTC7545ABN
DGND [3]	[18] V_{DD}	LTC7545ABSW
DB11 (MSB) [4]	[17] WR	LTC7545ACG
DB10 [5]	[16] CS	LTC7545ACN
DB9 [6]	[15] DB0 (LSB)	LTC7545ACSW
DB8 [7]	[14] DB1	LTC7545AKG
DB7 [8]	[13] DB2	LTC7545AKN
DB6 [9]	[12] DB3	LTC7545AKSW
DB5 [10]	[11] DB4	LTC7545ALG
G PACKAGE 20-LEAD PLASTIC SSOP		LTC7545ALN
N PACKAGE 20-LEAD PDIP		LTC7545ALSW
SW PACKAGE 20-LEAD PLASTIC SO WIDE		
$T_{JMAX} = XXX^{\circ}C$, $\theta_{JA} = XXX^{\circ}C/W$ (G)		
$T_{JMAX} = 150^{\circ}C$, $\theta_{JA} = 100^{\circ}C/W$ (N)		
$T_{JMAX} = 150^{\circ}C$, $\theta_{JA} = 130^{\circ}C/W$ (SW)		

Consult factory for Military grade parts.

ELECTRICAL CHARACTERISTICS

 $V_{DD} = 5V$ or $15V$, $V_{REF} = 10V$, $V_{OUT1} = AGND = 0V$, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS		LTC7545AK/AB			LTC7545AL/AC			UNITS	
				MIN	TYP	MAX	MIN	TYP	MAX		
Accuracy											
	Resolution			●	12			12		Bits	
INL	Integral Nonlinearity (Relative Accuracy)	(Note 1)	T _A = 25°C T _{MIN} to T _{MAX}	●		±0.5 ±0.5			±0.5 ±0.5	LSB LSB	
DNL	Differential Nonlinearity	Guaranteed Monotonic T _{MIN} to T _{MAX}	T _A = 25°C T _{MIN} to T _{MAX}	●		±1 ±1			±0.5 ±0.5	LSB LSB	
GE	Gain Error	(Note 2)	T _A = 25°C T _{MIN} to T _{MAX}	●		±2 ±3			±1 ±2	LSB LSB	
	Gain Temperature Coefficient	(Note 3)	ΔGain/ΔTemperature	●		1	5		1	5	ppm/°C
I _{LKG}	OUT1 Leakage Current	(Note 4)	T _A = 25°C T _{MIN} to T _{MAX}	●		±10 ±50			±10 ±50	nA nA	
PSRR	Power Supply Rejection			●		±0.002			±0.002		%/%
Reference Input											
R _{REF}	V _{REF} Input Resistance	(Note 5)		●	8	11	15	8	11	15	kΩ
AC Performance											
	Output Current Settling Time	(Notes 3, 6, 7)		●		1			1		μs
	Propagation Delay	(Notes 3, 6, 8)		●		150			150		ns
	Digital-to-Analog Glitch Impulse	(Notes 6, 9)		●		5			5		nV-sec
	Multiplying Feedthrough Error	V _{REF} = ±10V, 10kHz Sine Wave		●		5			5		mV _{P-P}
Analog Outputs											
C _{OUT}	Output Capacitance (Note 3)	DB0 to DB11 = 0V, WR, CS = 0V	C _{OUT1}	●		30	70		30	70	pF
		DB0 to DB11 = V _{DD} , WR, CS = 0V	C _{OUT1}	●		60	150		60	150	pF

ELECTRICAL CHARACTERISTICS

$V_{DD} = 5V$, $V_{REF} = 10V$, $V_{OUT1} = AGND = 0V$, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS	ALL GRADES			UNITS	
			MIN	TYP	MAX		
Digital Inputs							
V _{IH}	Digital Input High Voltage		●	2.4		V	
V _{IL}	Digital Input Low Voltage		●		0.8	V	
I _{IN}	Digital Input Current		●	0.001	±1	μA	
C _{IN}	Digital Input Capacitance	(Note 3) V _{IN} = 0V	●		8	pF	
Timing Characteristics (Note 3)							
t _{CS}	$\overline{CS}$ to $\overline{WR}$ Setup Time		●	100		ns	
t _{CH}	$\overline{CS}$ to $\overline{WR}$ Hold Time		●	0		ns	
t _{WR}	Write Pulse Width		●	100		ns	
t _{DS}	Data Setup Time		●	100		ns	
t _{DH}	Data Hold Time		●	5		ns	
Power Supply							
V _{DD}	Supply Voltage		●	4.75	5	5.25	V
I _{DD}	Supply Current	All Digital Inputs = V _{IH} or V _{IL}	●			2	mA
		All Digital Inputs = 0V or V _{DD}	●		10	100	μA

$V_{DD} = 15V$, $V_{REF} = 10V$, $V_{OUT1} = AGND = 0V$, $T_A = T_{MIN}$ to T_{MAX} , unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS	ALL GRADES			UNITS	
			MIN	TYP	MAX		
Digital Inputs							
V _{IH}	Digital Input High Voltage		●	13.5		V	
V _{IL}	Digital Input Low Voltage		●		1.5	V	
I _{IN}	Digital Input Current		●		±1	μA	
C _{IN}	Digital Input Capacitance	(Note 3) V _{IN} = 0V	●		8	pF	
Timing Characteristics (Note 3)							
t _{CS}	$\overline{CS}$ to $\overline{WR}$ Setup Time		●	75		ns	
t _{CH}	$\overline{CS}$ to $\overline{WR}$ Hold Time		●	0		ns	
t _{WR}	Write Pulse Width		●	75		ns	
t _{DS}	Data Setup Time		●	60		ns	
t _{DH}	Data Hold Time		●	5		ns	
Power Supply							
V _{DD}	Supply Voltage		●	14.25	15	15.75	V
I _{DD}	Supply Current	All Digital Inputs = V _{IH} or V _{IL}	●			2	mA
		All Digital Inputs = 0V or V _{DD}	●		10	100	μA

The ● denotes specifications which apply over the full operating temperature range.

Note 1: $\pm 0.5LSB = \pm 0.012\%$ of full scale.

Note 2: Using internal feedback resistor.

Note 3: Guaranteed by design, not subject to test.

Note 4: I_{OUT1} with DAC register loaded to all 0s.

Note 5: Typical temperature coefficient is 100ppm/°C.

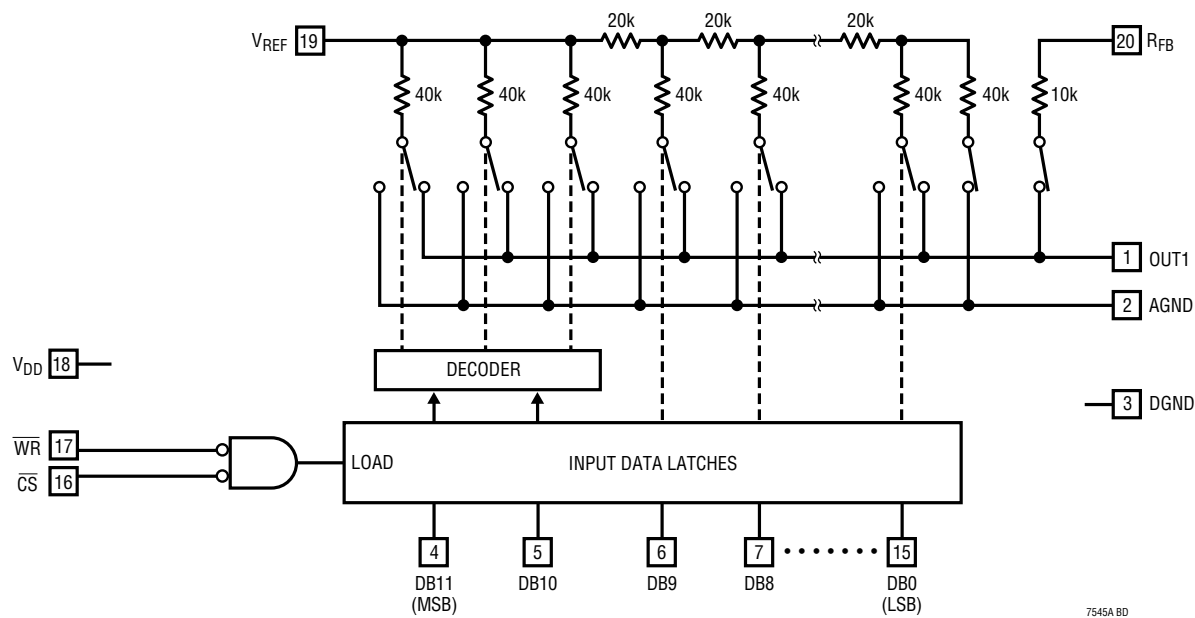
Note 6: $OUT1$ load = 100Ω in parallel with 13pF.

Note 7: To 0.01% for a full-scale change, measured from the falling edge of $\overline{WR}$, $\overline{CS} = 0V$.

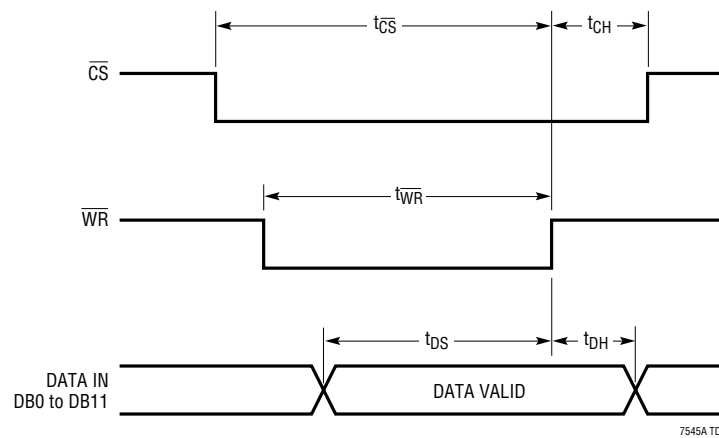
Note 8: From digital input change to 90% of final analog output.

Note 9: $V_{REF} = 0V$. DAC register contents changed from all 0s to all 1s or all 1s to all 0s.

BLOCK DIAGRAM



TIMING DIAGRAM



TYPICAL APPLICATIONS

Unipolar Operation (2-Quadrant Multiplication)

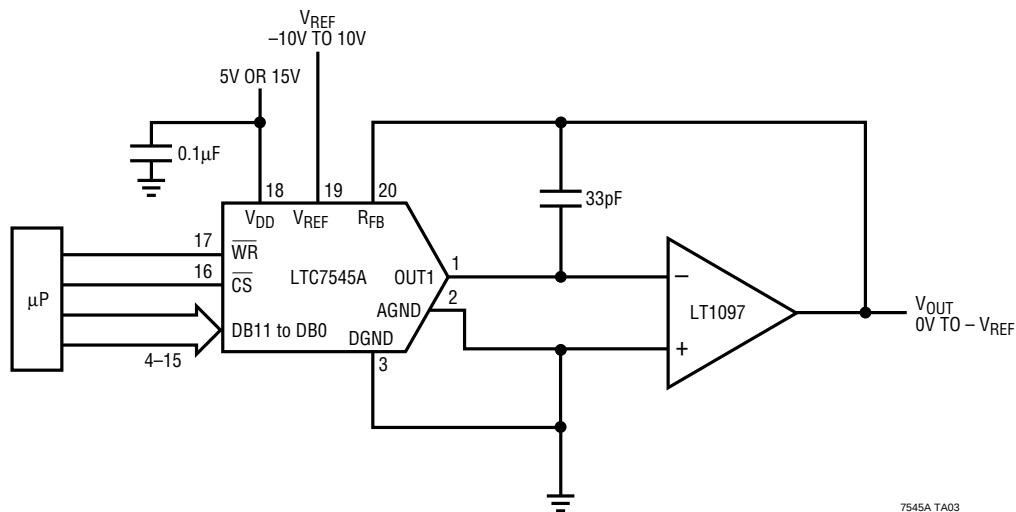
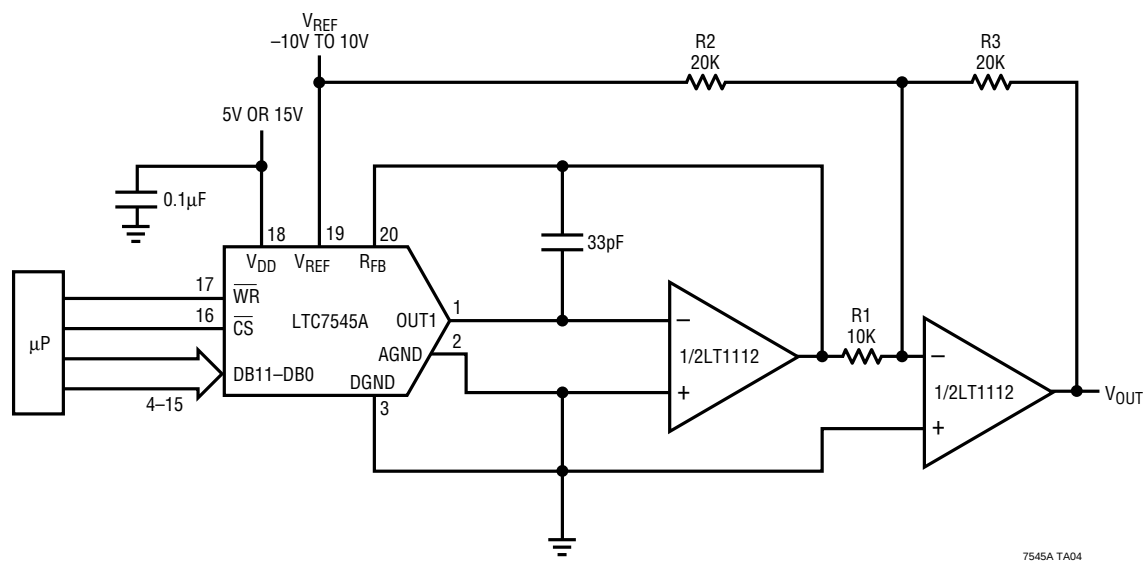


Table 1. Unipolar Binary Code Table

DIGITAL INPUT BINARY NUMBER IN DAC LATCH			ANALOG OUTPUT V_{OUT}
MSB		LSB	
1111	1111	1111	$-V_{REF} (4095/4096)$
1000	0000	0000	$-V_{REF} (2048/4096) = -V_{REF}/2$
0000	0000	0001	$-V_{REF} (1/4096)$
0000	0000	0000	0V

TYPICAL APPLICATIONS

Bipolar Operation (4-Quadrant Multiplication)



7545A TA04

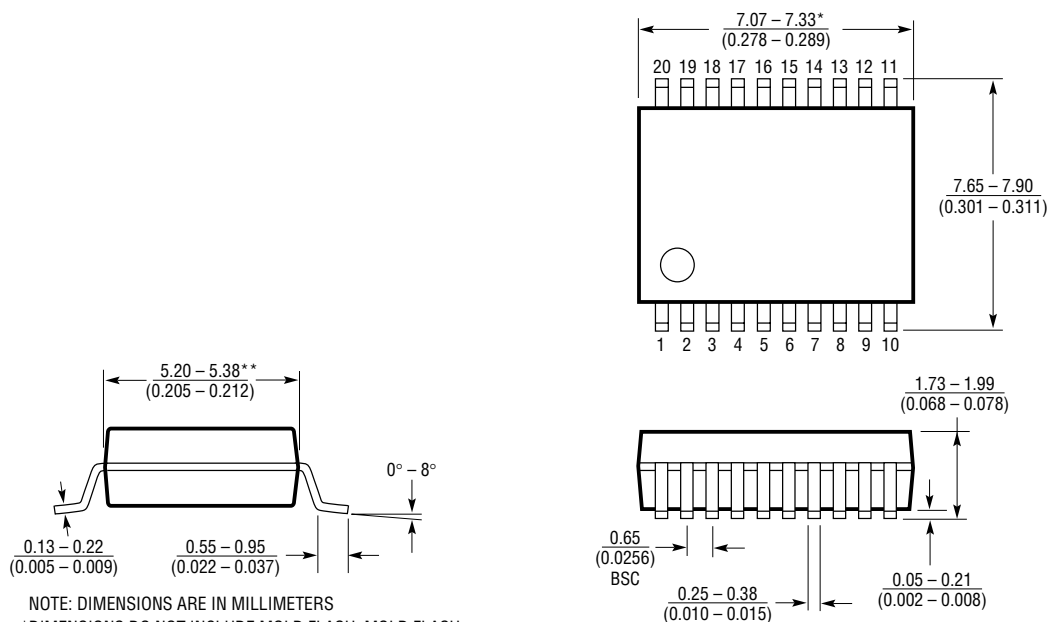
Table 2. Bipolar Offset Binary Code Table

DIGITAL INPUT BINARY NUMBER IN DAC LATCH			ANALOG OUTPUT V_{OUT}
MSB		LSB	
1111	1111	1111	V_{REF} (2047/2048)
1000	0000	0001	V_{REF} (1/2048)
1000	0000	0000	0V
0111	1111	1111	$-V_{REF}$ (1/2048)
0000	0000	0000	$-V_{REF}$ (2048/2048) = $-V_{REF}$

PACKAGE DESCRIPTION

Dimensions in inches (millimeters) unless otherwise noted.

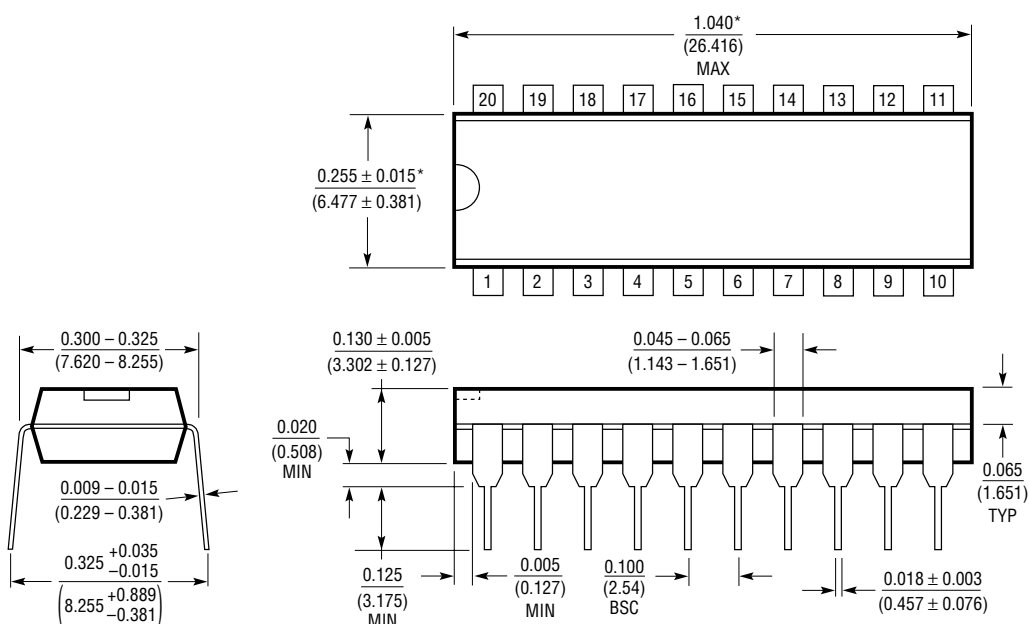
G Package 20-Lead Plastic SSOP (0.209) (LTC DWG # 05-08-1640)



NOTE: DIMENSIONS ARE IN MILLIMETERS
 *DIMENSIONS DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.152mm (0.006") PER SIDE
 **DIMENSIONS DO NOT INCLUDE INTERLEAD FLASH. INTERLEAD FLASH SHALL NOT EXCEED 0.254mm (0.010") PER SIDE

G20 SSOP 1098

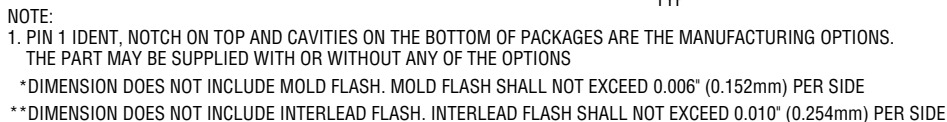
N Package 20-Lead PDIP (Narrow 0.300) (LTC DWG # 05-08-1510)



*THESE DIMENSIONS DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS.
 MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.010 INCH (0.254mm)

N20 1098

(LTC DWG # 05-08-1620)



	77.5	88.1
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